Crystal Oscillator (SPXO)

- Package size (2.0 mm × 1.6 mm × 0.7 mm)
- · Fundamental mode SPXO
- · Output: CMOS
- · Reference weight Typ.9.9 mg
- [1] Product Number / Product Name / Marking
- (1-1) Product Number / Ordering Code

X1G0048010014xx

Last 2 digits code(**xx**) defines Quantity. The standard is "00", 3 000 pcs/Reel.

(1-2) Product Name / Model Name

SG2016CAN 16.000000 MHz TJGA

[2] Operating Range

[2] Operating Nating						
Parameter	Symbol	Specifications			Unit	Conditions
Farameter	Symbol	Min.	Тур.	Max.	Offic	Conditions
Supply voltage	V_{CC}	1.60	-	3.63	V	-
Supply voltage	GND	0	-	0	V	-
Operating temperature range	T_use	-40	-	+85	°C	-
CMOS load condition	L_CMOS	-	-	15	pF	-

[3] Frequency Characteristics

(Unless stated otherwise [2] Operating Range)

Parameter	Symbol	Specifications		Unit	Conditions	
Parameter	Symbol	Min.	Тур.	Max.	Offic	Conditions
Output frequency	fo	-	16.000000	-	MHz	-
Frequency tolerance *1	f_tol	-50	-	+50	×10 ⁻⁶	T_use
Frequency aging	f_age	-3	-	+3	×10 ⁻⁶	+25 °C, First year

^{*1} Frequency tolerance includes Initial frequency tolerance, Frequency / temperature characteristics, Frequency / voltage coefficient and Frequency / load coefficient.

[4] Electrical Characteristics

(Unless stated otherwise [2] Operating Range)

[4] Liectifical Character	iicoo otatea	otherwise [2] Operating Mange)				
Doromotor	Cymahal	5	Specification	าร	الما ا	Conditions
Parameter	Symbol	Min.	Тур.	Max.	Unit	
Start-up time	t_str	-	-	3.0	ms	t = 0 at 90 % Vcc
Current consumption	I _{cc}	-	-	1.8	mA	No load condition, Vcc = 3.3 V
Stand-by current	I_std	-	-	2.7	μΑ	ST = GND, Vcc = 3.3 V
Output voltage	V _{OH}	90 % Vcc	-	-	V	Iон = -4 mA @Vcc = 3.3 V
Output voltage	V _{OL}	-	-	10 % Vcc	V	IoL = 4 mA @Vcc = 3.3 V
Rise time	tr	-	-	3.5	ns	20 % Vcc to 80 % Vcc Level, L_CMOS = 15 pF, Vcc = 1.8 V ± 10 %
Fall time	tf	-	-	3.5	ns	80 % Vcc to 20 % Vcc Level, L_CMOS = 15 pF, Vcc = 1.8 V ± 10 %
Symmetry	SYM	45	-	55	%	50 % Vcc Level, L_CMOS ≤ 15 pF
Input voltage	V _{IH}	80 % Vcc	-	-	V	ST terminal
Input voltage	V _{IL}	_	-	20 % Vcc	V	ST terminal
Output disable time (ST)	tstp_st	-	-	100	ns	ST terminal HIGH → LOW
Output enable time (ST)	tsta_st	-	-	3	ms	ST terminal LOW → HIGH

[For other general specifications, please refer to the attached Full Data Sheet below]

Crystal oscillator: SG2016/3225/5032/7050CAN & SG-210STF

Features

Crystal oscillator (SPXO)

Frequency: 20 standard frequencies

(4 MHz to 72 MHz)

Output: CMOS

Supply voltage: 1.6 V to 3.63 V
 Operating temperature: -20 °C to +70 °C

-40 °C to +105 °C

Applications

- IoT, Wearable device
- Data center, Storage
- Medical, Industrial automation



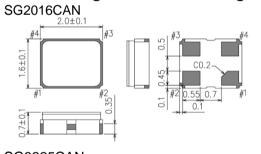
Description

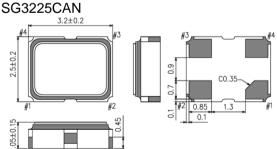
Epson's SGxxxxCAN & SG-210STF are Simple Packaged Crystal Oscillator (SPXO) series with CMOS output. These SPXO's are ideal for variety of applications from IoT, wearables, medical, industrial automation, etc.

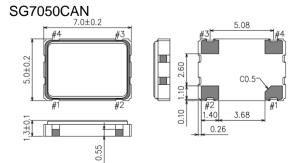
These SPXO have low current consumption, wide operating voltage from 1.6 V to 3.63 V and wide operating temperature range from -40 °C to 85 °C, in addition operation up to 105 °C is available.

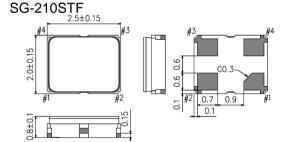
These SPXO's are available in five different package size from 2.0×1.6 mm to 7.0×5.0 mm and available in standard pin out's.

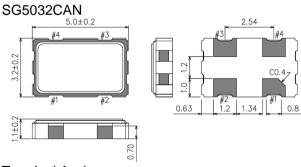
Outline Drawing and Terminal Assignment











Terminal Assignment

Pin #	Connection	Function				
	ST	ST terminal	ST terminal			
#1		ST function	Osc. Circuit	Output		
#1		"H" or OPEN	Oscillation	Specified frequency : Enable		
		"L"	Oscillation stop	High impedance : Disable		
#2	GND	GND terminal				
#3	OUT	Output terminal				
#4	Vcc	V _{CC} terminal				

Page 2 / 35 Spec No : SGxxxxCAN_E_Ver1.94

[1] Product Name / Product Number

(1-1) SG2016CAN

(1) Product Name (Standard Form)

SG2016 CAN 25.000000MHz TJHA

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4567

①Model ②Output (C:CMOS) ③Frequency ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature ⑦Internal identification code ("A" is default)

Supply voltage Refer to Figure 1						
Т	T 1.8 V to 3.3 V Typ.					
K	2.5 V to 3.3 V Typ.					

(5) Frequency tolerance / (6) Operating temperature						
	$\pm 25 \times 10^{-6}$ / -20 °C to +70 °C					
G	$\pm 50 \times 10^{-6}$ / -40 °C to +85 °C					
	6					

*Figure 1 is on the next page

JH $\pm 50 \times 10^{-6}$ / -40 °C to +85 °C

(2) Product Number / Ordering Code

duct (valide) / Graeni	Frequency tolerance / Operating temperature				
Frequency [MHz]	DB	JG	JH		
Frequency [Mi12]	±25 × 10 ⁻⁶	$\pm 50 \times 10^{-6}$	$\pm 50 \times 10^{-6}$		
	-20 °C to +70 °C	-40 °C to +85 °C	-40 °C to +105 °C		
4	-	X1G004801003000	X1G004801004900		
8	-	X1G004801004500	X1G004801004600		
10	•	X1G004801002900	X1G004801002700		
12	X1G004801005000	X1G004801000700	X1G004801005100		
12.288	X1G004801005200	X1G004801004400	X1G004801005300		
14.7456	•	X1G004801005400	X1G004801005500		
16	-	X1G004801001400	X1G004801005600		
20	X1G004801005700	X1G004801005800	X1G004801001800		
24	X1G004801005900	X1G004801000200	X1G004801004000		
24.576	-	X1G004801006000	X1G004801003100		
25	X1G004801002400	X1G004801001200	X1G004801003500		
26	•	X1G004801000300	X1G004801003900		
27	•	X1G004801006100	X1G004801002100		
32	•	X1G004801006200	X1G004801006300		
33.33	•	X1G004801006400	X1G004801006500		
33.3333	-	X1G004801002600	X1G004801006600		
40	-	X1G004801006700	X1G004801003600		
48	X1G004801006800	X1G004801002000	X1G004801006900		
50	X1G004801007000	X1G004801001300	X1G004801002800		
72	X1G004801007100	X1G004801007200	X1G004801007300		

Page 3 / 35 Spec No : SGxxxxCAN_E_Ver1.94

(1-2) SG-210STF

(1) Product Name (Standard Form)

SG-210 STF 25.000000MHz Y

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①Model ②Function (S:Standby) ③Supply voltage

③Supply voltage Refer to Figure 1 T 1.8 V to 3.3 V Typ.

*Figure 1 is on the next page

⑤Fr	⑤ Frequency tolerance / Operating temperature					
S	S $\pm 25 \times 10^{-6}$ / -20 °C to +70 °C					
L	$\pm 50 \times 10^{-6}$ / -40 °C to +85 °C					
Υ	$\pm 50 \times 10^{-6}$ / -40 °C to +105 °C					

(2) Product Number / Ordering Code

	Frequency	tolerance / Operating to	emperature
Frequency [MHz]	S	L	Υ
Frequency [ivii iz]	±25 × 10 ⁻⁶	$\pm 50 \times 10^{-6}$	$\pm 50 \times 10^{-6}$
	-20 °C to +70 °C	-40 °C to +85 °C	-40 °C to +105 °C
4	•	X1G004171000900	X1G004171029900
8	-	X1G004171001500	X1G004171006900
10	•	X1G004171001600	X1G004171036500
12	X1G004171016300	X1G004171001800	X1G004171028000
12.288	X1G004171006100	X1G004171001900	X1G004171036600
14.7456	•	X1G004171002500	X1G004171036700
16	•	X1G004171002700	X1G004171015400
20	X1G004171021800	X1G004171002900	X1G004171023800
24	X1G004171015600	X1G004171003100	X1G004171019700
24.576	-	X1G004171003200	X1G004171036800
25	X1G004171007700	X1G004171003300	X1G004171005900
26	-	X1G004171003400	X1G004171024400
27	-	X1G004171003500	X1G004171025000
32	-	X1G004171004000	X1G004171012700
33.33	-	X1G004171011900	X1G004171030000
33.3333	-	X1G004171012000	X1G004171007500
40	-	X1G004171004500	X1G004171020600
48	X1G004171007800	X1G004171004600	X1G004171036900
50	X1G004171007900	X1G004171004700	X1G004171012600
72	X1G004171037000	X1G004171012400	X1G004171037100

Page 4 / 35

Spec No : SGxxxxCAN_E_Ver1.94

(1-3) SG3225CAN

(1) Product Name (Standard Form)

<u>SG3225 C AN</u> <u>25.000000MHz</u> <u>T J H A</u>

① ②

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①Model ②Output (C:CMOS) ③Frequency ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature ⑦Internal identification code ("A" is default)

Supply voltage Refer to Figure 1							
Т	1.8 V to 3.3 V Typ.						
K	2.5 V to 3.3 V Typ.						

	⑤ Frequency tolerance / ⑥ Operating temperature						
DB $\pm 25 \times 10^{-6}$ / -20 °C to +70 °C							
	JG	$\pm 50 \times 10^{-6}$ / -40 °C to +85 °C					
	J	$\pm 50 \times 10^{-6}$ / -40 °C to +105 °C					

*Figure 1 is on the next page

(2) Product Number / Ordering Code

	Frequency	tolerance / Operating te	emperature
Frequency [MHz]	DB	JG	JH
riequency [ivii iz]	±25 × 10 ⁻⁶	$\pm 50 \times 10^{-6}$	$\pm 50 \times 10^{-6}$
	-20 °C to +70 °C	-40 °C to +85 °C	-40 °C to +105 °C
4	•	X1G005961001115	X1G005961001215
8	-	X1G005961000415	X1G005961001315
10	•	X1G005961000515	X1G005961001415
12	X1G005961001515	X1G005961000615	X1G005961001615
12.288	X1G005961001715	X1G005961001815	X1G005961001915
14.7456	•	X1G005961002015	X1G005961002115
16	•	X1G005961002215	X1G005961002315
20	X1G005961002415	X1G005961000715	X1G005961002515
24	X1G005961002615	X1G005961000115	X1G005961002715
24.576	•	X1G005961000815	X1G005961002815
25	X1G005961002915	X1G005961000215	X1G005961003015
26	•	X1G005961003115	X1G005961003215
27	•	X1G005961003315	X1G005961003415
32	-	X1G005961003515	X1G005961003615
33.33	•	X1G005961003715	X1G005961003815
33.3333	•	X1G005961003915	X1G005961004015
40	-	X1G005961000915	X1G005961004115
48	X1G005961004215	X1G005961000315	X1G005961004315
50	X1G005961004415	X1G005961001015	X1G005961004515
72	X1G005961004615	X1G005961004715	X1G005961004815

Page 5 / 35 Spec No : SGxxxxCAN_E_Ver1.94

(1-4) SG5032CAN

(1) Product Name (Standard Form)

<u>SG5032 C AN</u> <u>25.000000MHz</u> <u>T J H A</u>

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①Model ②Output (C:CMOS) ③Frequency ④Supply voltage

⑤ Frequency tolerance ⑥ Operating temperature ⑦ Internal identification code ("A" is default)

Ī	4 Supply voltage Refer to Figure 1						
Ī	Т	1.8 V to 3.3 V Typ.					
Ī	K	2.5 V to 3.3 V Typ.					

⊚Fr	⑤Frequency tolerance / ⑥Operating temperature					
DB	$\pm 25 \times 10^{-6}$ / -20 °C to +70 °C					
JG	$\pm 50 \times 10^{-6}$ / -40 °C to +85 °C					
JН	+50 × 10 ⁻⁶ / -40 °C to +105 °C					

*Figure 1 is on the next page

(2) Product Number / Ordering Code

dact (Valliber / Ordelii	Frequency tolerance / Operating temperature							
Fine sure in ext [NALL=1]	DB	JG	JH					
Frequency [MHz]	±25 × 10 ⁻⁶	±50 × 10 ⁻⁶	±50 × 10 ⁻⁶					
	-20 °C to +70 °C	-40 °C to +85 °C	-40 °C to +105 °C					
4	-	X1G004451003400	X1G004451019600					
8	-	X1G004451002100	X1G004451019700					
10	-	X1G004451001300	X1G004451017800					
12	X1G004451019800	X1G004451002800	X1G004451019900					
12.288	X1G004451020000	X1G004451000100	X1G004451020100					
14.7456	-	X1G004451001900	X1G004451020200					
16	-	X1G004451000200	X1G004451020300					
20	X1G004451020400	X1G004451001100	X1G004451020500					
24	X1G004451017200	X1G004451000300	X1G004451020600					
24.576	-	X1G004451002900	X1G004451020700					
25	X1G004451009700	X1G004451000400	X1G004451020800					
26	-	X1G004451008200	X1G004451020900					
27	-	X1G004451000500	X1G004451021000					
32	-	X1G004451001400	X1G004451021100					
33.33	-	X1G004451021200	X1G004451021300					
33.3333	-	X1G004451016700	X1G004451021400					
40	-	X1G004451001200	X1G004451021500					
48	X1G004451014900	X1G004451000700	X1G004451011200					
50	X1G004451011500	X1G004451000800	X1G004451003600					
72	X1G004451021600	X1G004451021700	X1G004451021800					

Page 6 / 35

Spec No : SGxxxxCAN_E_Ver1.94

(1-5) SG7050CAN

(1) Product Name (Standard Form)

SG7050 C AN 25.000000MHz T J H A

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①Model ②Output (C:CMOS) ③Frequency ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature ⑦Internal identification code ("A" is default)

4 S	Supply voltage Refer to Figure 1							
Т	1.8 V to 3.3 V Typ.							
K	2.5 V to 3.3 V Typ.							

⊚Fr	⑤Frequency tolerance / ⑥Operating temperature					
DB	$\pm 25 \times 10^{-6}$ / -20 °C to +70 °C					
JG	$\pm 50 \times 10^{-6}$ / -40 °C to +85 °C					
ЛН	+50 × 10 ⁻⁶ / -40 °C to +105 °C					

*Figure 1 is on the next page

(2) Product Number / Ordering Code

	Frequency	Frequency tolerance / Operating temperature					
Eroguopov [MHz]	DB	JG	JH				
Frequency [MHz]	±25 × 10 ⁻⁶	±50 × 10 ⁻⁶	±50 × 10 ⁻⁶				
	-20 °C to +70 °C	-40 °C to +85 °C	-40 °C to +105 °C				
4	•	X1G004481005100	X1G004481025200				
8	•	X1G004481001400	X1G004481025300				
10	-	X1G004481000500	X1G004481025400				
12	X1G004481025500	X1G004481000600	X1G004481025600				
12.288	X1G004481025700	X1G004481000100	X1G004481025800				
14.7456	-	X1G004481002500	X1G004481025900				
16	-	X1G004481000700	X1G004481026000				
20	X1G004481012800	X1G004481000800	X1G004481026100				
24	X1G004481002200	X1G004481000200	X1G004481026200				
24.576	-	X1G004481001600	X1G004481026300				
25	X1G004481011600	X1G004481000300	X1G004481026400				
26	-	X1G004481003500	X1G004481026500				
27	•	X1G004481000400	X1G004481026600				
32	-	X1G004481000900	X1G004481026700				
33.33	•	X1G004481017900	X1G004481026800				
33.3333	-	X1G004481003300	X1G004481026900				
40	-	X1G004481001500	X1G004481027000				
48	X1G004481022600	X1G004481001100	X1G004481027100				
50	X1G004481011200	X1G004481001200	X1G004481016000				
72	X1G004481027200	X1G004481018300	X1G004481027300				

Page 7 / 35 Spec No : SGxxxxCAN_E_Ver1.94

[2] Absolute Maximum Ratings

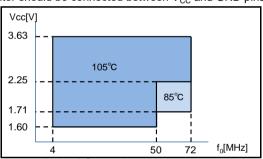
Parameter	Symbol		Specification	1	Unit	Conditions
Faiametei	Symbol	Min.	Тур.	Max.		
Maximum supply voltage	V_{CC}	-0.3	-	4	V	
Input voltage	Vin	-0.3	-	$V_{CC} + 0.3$	V	ST terminal
Storage temperature range	Teta	-55	-	+125	°C	SG2016CAN
Storage temperature range	T_stg	-40	-	+125	°C	All other

[3] Operating Range

Parameter	Symbol	Specification			Unit	Conditions
Farameter	Symbol	Min.	Тур.	Max.	Offic	Conditions
		1.6	-	3.63	V	fo ≤ 50 MHz, T_use = +105 °C Max.
Supply voltage	V _{CC}	1.71	·	3.63	٧	fo = 72 MHz, T_use = +85 °C Max.
		2.25	-	3.63	V	fo = 72 MHz, T_use = +105 °C Max.
Supply voltage	GND	0.0	0.0	0.0	V	
		-20	+25	+70	°C	
Operating temperature range (Refer to Figure 1)	T_use	-40	+25	+85	۰C	
(iterer to rigare 1)		-40	+25	+105	۰C	
CMOS load condition	L_CMOS	-	-	15	pF	

 $^{^*}$ Power supply startup time (0 $\%V_{CC} \rightarrow 90~\%V_{CC})$ should be more than 150 μs

^{*} A 0.01 µF to a 0.1 µF bypass capacitor should be connected between V_{CC} and GND pins located close to the device



Please note that Supply voltage range (V_{CC}) depends on Output frequency(fo) and upper limit of Operating temperature(T_use Max.).

Figure 1: The upper limit of Operating temperature and the related conditions

[4] Frequency Characteristics

(Unless stated otherwise [3] Operating Range)

(* ************************************						
Parameter	Symbol	Specification			Unit	Conditions
r arameter	Symbol	Min.	Тур.	Max.	Offic	Conditions
Output frequency	fo	4, 8, 10, 12, 12.288, 14.7456, 16, 20, 24, 24.576, 25, 26, 27, 32, 33.33, 33.3333, 40, 48, 50, 72			MHz	
		-50	-	+50	×10 ⁻⁶	T_use = -20 °C to +70 °C
Frequency tolerance *1	f_tol	-100		+100	×10 ⁻⁶	T_use = -40 °C to +105 °C T_use = -40 °C to +85 °C *2
Frequency aging	f_age	-3		+3	×10 ⁻⁶	+25 °C, First year

^{*1} Frequency tolerance includes initial frequency tolerance, temperature variation, supply voltage change and load drift.

Spec No: SGxxxxCAN_E_Ver1.94

^{*2} This temperature range is only for fo = 75 MHz

[5] Electrical Characteristics

(Unless stated otherwise [3] Operating Range)

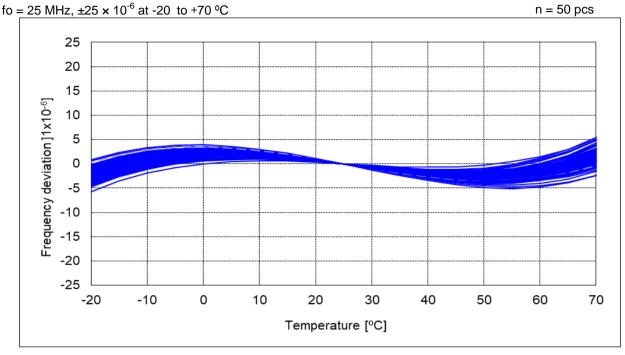
Dave meeter.	Currele el	Specification			1.1	On although
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Start-up time	t_str	-	-	3	ms	t = 0 at 90 %V _{CC}
Comment of the second s		-	-	1.5	mA	1 MHz \leq fo \leq 20 MHz
Current consumption (No load) $V_{CC} = 1.8 \text{ V} \pm 10 \text{ \%}$		-	-	1.8	mA	20 MHz < fo ≤ 40 MHz
V CC = 1.0 V ± 10 70		-	-	2.1	mA	40 MHz < fo ≤ 50 MHz
V _{CC} = 1.8 V ± 5 %		-	-	2.4	mA	fo = 72 MHz
		-	-	1.6	mA	1 MHz \leq fo \leq 20 MHz
Current consumption (No load)		-	-	2.0	mA	20 MHz < fo ≤ 40 MHz
$V_{CC} = 2.5 \text{ V} \pm 10 \%$	I _{cc}	-	-	2.4	mA	40 MHz < fo ≤ 50 MHz
		-	-	2.8	mA	fo = 72 MHz
		-	-	1.8	mA	1 MHz \leq fo \leq 20 MHz
Current consumption (No load)		-	-	2.2	mA	20 MHz < fo ≤ 40 MHz
$V_{CC} = 3.3 \text{ V} \pm 10 \%$		-	-	2.6	mA	40 MHz < fo ≤ 50 MHz
		-	-	3.0	mA	fo = 72 MHz
	I_std	-	-	2.1	μA	$V_{CC} = 1.8 \text{ V} \pm 10 \text{ % or } \pm 5 \text{ %},$ $\overline{ST} = \text{GND}$
Stand-by current		-	-	2.5	μΑ	$V_{CC} = 2.5 \text{ V} \pm 10 \%, \overline{ST} = \text{GND}$
		-	-	2.7	μΑ	$V_{CC} = 3.3 \text{ V} \pm 10 \%, \overline{ST} = \text{GND}$
	V_{OH}	90 % V _{CC}	-	-	V	Load current condition 1.8 V ± 10 % 2.5 V ± 10 % 3.3 V ± 10 %
Output voltage	V _{OL}	-	-	10 % V _{CC}	V	O _H -1.5 mA -3 mA -4 mA O _L 1.5 mA 3 mA 4 mA Load current condition 1.8 V ± 10 % 2.5 V ± 10 % 3.3 V ± 10 % O _H -1.5 mA -3 mA -4 mA O _L 1.5 mA 3 mA 4 mA
Cutput voltage	V _{OH}	V _{CC} - 0.4	-	-	V	
	V _{OL}	-	-	0.4	V	
Symmetry	SYM	45	50	55	%	50 % V _{CC} level, L_CMOS ≤ 15 pF
Rise time / Fall time	tr / tf	-	-	3	ns	$V_{CC} = 2.5 \text{ V or } 3.3 \text{ V } \pm 10 \text{ %},$ $20 \text{ % } V_{CC} \text{ to } 80 \text{ % } V_{CC} \text{ Level},$ $L_\text{CMOS} = 15 \text{ pF}$
INISE UITIE / FAII UITIE	u / u	-	-	3.5	ns	$V_{CC} = 1.8 \text{ V} \pm 10 \text{ % or } \pm 5 \text{ %},$ 20 % V_{CC} to 80 % V_{CC} Level, $L_CMOS = 15 \text{ pF}$
Input voltage	V_{IH}	80 % Vcc	-	-	V	
Input voltage	V _{IL}	-	-	20 % Vcc	V	31 terminai
Output disable time (ST)	tstp_st	-	-	100	ns	ST terminal HIGH → LOW
Output enable time (ST)	tsta_st	-	-	3	ms	ST terminal LOW → HIGH

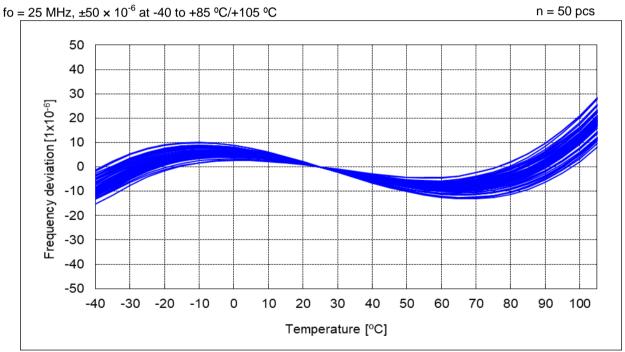
[6] Thermal resistance (For reference only)

Parameter	Cymbol	Specification			l lait	Conditions
Falametei	Symbol	Min.	Тур.	Max.	Unit	Conditions
Junction temperature	Tj	-	-	+125	°C	
		-	10	-	°C/W	SG2016CAN
		-	15	-	°C/W	SG-210STF
Junction to case	θјс	-	28	-	°C/W	SG3225CAN
		-	16	-	°C/W	SG5032CAN
		-	23	-	°C/W	SG7050CAN
		-	100	-	°C/W	SG2016CAN
		-	92	-	°C/W	SG-210STF
Junction to ambient	θја	-	79	-	°C/W	SG3225CAN
		-	82	-	°C/W	SG5032CAN
		-	104	-	°C/W	SG7050CAN

Page 9 / 35 Spec No : SGxxxxCAN_E_Ver1.94

[7] Typical Performance Characteristics (For reference only)
 The following data shows typical performance characteristics
 (7-1) Frequency / Temperature Characteristics





Page 10 / 35 Spec No : SGxxxxCAN_E_Ver1.94

(7-2) Current Consumption No load, T_use = +25 °C, Freq. Dependency L_CMOS = 15 pF, T_use = +25 °C, Freq. Dependency 2.0 6.0 Current consumption (I_{CC}) [mA] consumption (Icc) [mA] 5.0 1.5 4.0 3.0 2.0 Current 0.5 Vcc=1.8 V Vcc=2.5 V 1.0 Vcc=2.5 V Vcc=3.3 V Vcc=3.3 V 0.0 0.0 15 20 25 30 35 40 45 50 55 60 65 20 25 30 35 40 fo [MHz] fo [MHz] fo = 20 MHzL_CMOS = 5 pF, Temperature Characteristic T_use = +25 °C, Output load(L_CMOS) Characteristics 4.5 45 4.0 -Vcc=2.5.V [mA] 4.0 (lcc) Vcc=3.3 V 3.5 3.5 (lcc) 3.0 3.0 Current consumption 2.5 2.5 2.0 2.0 1.5 1.5 1.0 1.0 -Vcc=2.5 V 0.5 0.5 Vcc=3.3 V 0.0 -40 -30 -20 -10 0 10 20 30 40 50 10 Temperature [°C] Output load [pF] fo = 40 MHzT_use = +25 °C, Output load(L_CMOS) Characteristics L CMOS = 5 pF, Temperature Characteristic 10.0 10.0 9.0 9.0 M. 8.0 ► Vcc=2.5 V <u>M</u> 8.0 (lcc) Vcc=3.3 V 7.0 7.0 (lcc) 6.0 6.0 Current consumption 5.0 5.0 4.0 4.0 3.0 3.0 Current 2.0 2.0 1.0 1.0 Vcc=3.3 V 0.0 -40 -30 -20 -10 20 30 40 50 70 0 10 Temperature [°C] fo = 72 MHzL_CMOS = 5 pF, Temperature Characteristic T_use = +25 °C, Output load(L_CMOS) Characteristics 14.0 14.0 -Vcc=1.8 V 至 12.0 12.0 -Vcc=2.5 V <u></u> 10.0 Vcc=3.3 V 10.0 consumption Current consumption 8.0 8.0 6.0 6.0 Current 4.0 4.0 2.0 Vcc=2.5 V 2.0 -Vcc=3.3 V 0.0 0.0 -40 -30 -20 -10 0 10 20 30 40 50 70 80

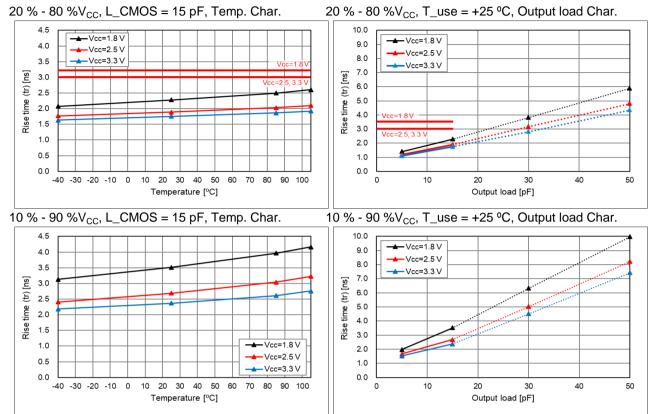
The actual current consumption is the total of the current under the condition of no load and the current to drive the output load (fo \times L_CMOS \times V_{CC}). To reduce the current consumption, it is effective to use lower frequency, lower supply voltage and lower output load.

Output load [pF]

^{*} Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

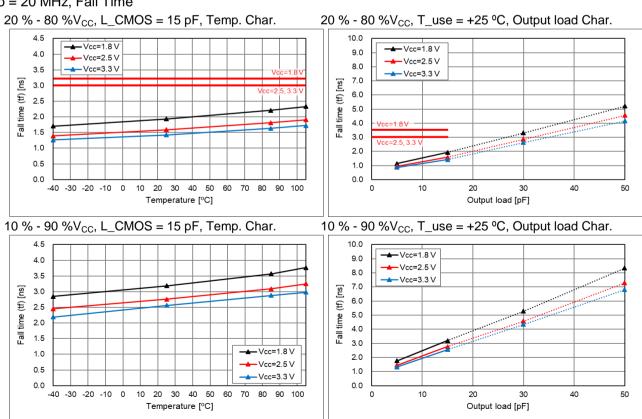
(7-3) Rise Time / Fall Time

fo = 20 MHz, Rise Time



^{*} Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

fo = 20 MHz, Fall Time



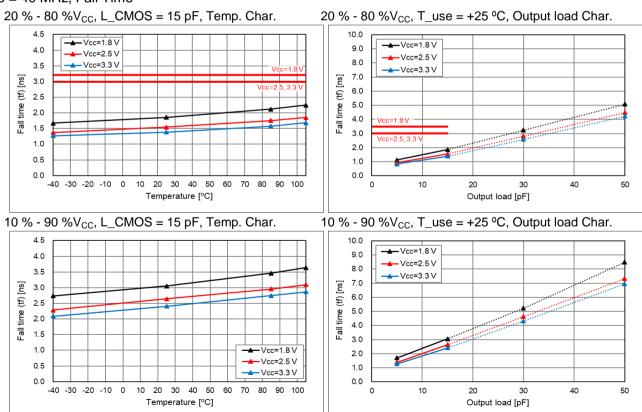
^{*} Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

(7-3) Rise Time / Fall Time [cont'd]

fo = 40 MHz, Rise Time

 $20 \% - 80 \%V_{CC}$, L_CMOS = 15 pF, Temp. Char. 20 % - 80 %V_{CC}, T_use = +25 °C, Output load Char. -Vcc=1.8 V ___Vcc=1.8 V 9.0 4.0 -Vcc=2.5 V -Vcc=2.5 V 8.0 3.5 -Vcc=3.3 V -Vcc=3.3 V 7.0 (tr) [ns] [ns] 3.0 6.0 Ξ 2.5 time 5.0 time 2.0 4.0 Rise 1.5 3.0 1.0 2.0 0.5 1.0 0.0 0.0 -40 -30 -20 -10 0 10 20 30 40 50 60 70 80 90 100 10 50 10 % - 90 %V_{CC}, L_CMOS = 15 pF, Temp. Char. 10 % - 90 % V_{CC} , $T_use = +25$ °C, Output load Char. -Vcc=1.8 V 9.0 4.0 -Vcc=2.5 V 8.0 3.5 Vcc=3.3 V 7.0 ns [ns] 3.0 6.0 $\overline{\Xi}$ Ξ 2.5 5.0 time 2.0 4.0 Rise 1.5 3.0 1.0 2.0 Vcc=2.5 V 0.5 1.0 0.0 -40 -30 -20 -10 0 10 20 30 40 50 70 80 10 50

fo = 40 MHz, Fall Time



^{*} Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

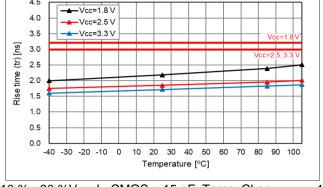
^{*} Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

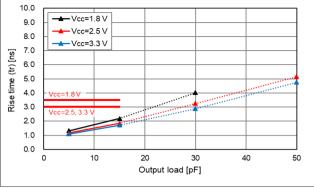
(7-3) Rise Time / Fall Time [cont'd]

fo = 72 MHz, Rise Time

 $20 \% - 80 \%V_{CC}$, L_CMOS = 15 pF, Temp. Char.

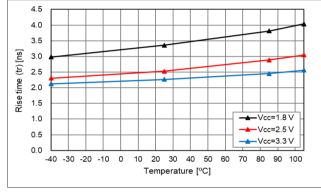
20 % - 80 %V_{CC}, T_use = +25 °C, Output load Char.

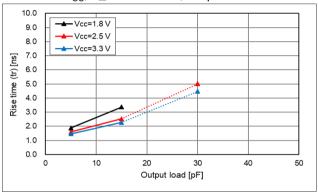




10 % - 90 %V_{CC}, L_CMOS = 15 pF, Temp. Char.

10 % - 90 % V_{CC} , $T_use = +25$ °C, Output load Char.



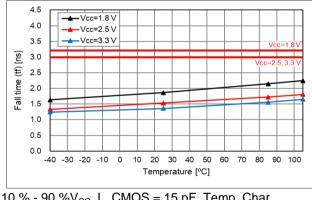


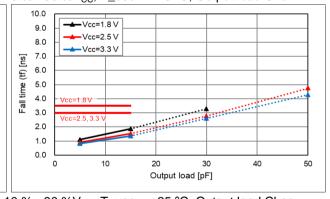
^{*} Output load condition under L CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference. There are some missing data in the graph. It is unmeasurable because of low amplitude under the condition of L CMOS > 15 pF.

fo = 72 MHz, Fall Time

20 % - 80 %V_{CC}, L_CMOS = 15 pF, Temp. Char.

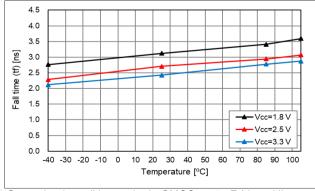
20 % - 80 % V_{CC} , $T_use = +25$ °C, Output load Char.

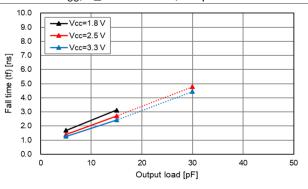




10 % - 90 %V_{CC}, L_CMOS = 15 pF, Temp. Char.

10 % - 90 % V_{CC} , $T_use = +25$ °C, Output load Char.



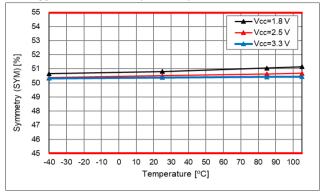


^{*} Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference. There are some missing data in the graph. It is unmeasurable because of low amplitude under the condition of $L_CMOS > 15 pF.$

(7-4) Symmetry

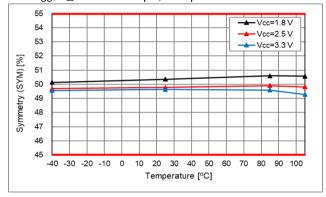
fo = 20 MHz

50 % V_{CC} , L_CMOS = 15 pF, Temp. Char.



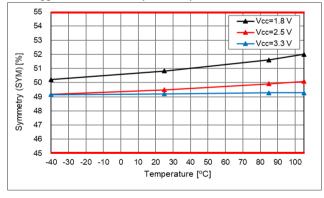
fo = 40 MHz

50 % V_{CC} , L_CMOS = 15 pF, Temp. Char.



fo = 72 MHz

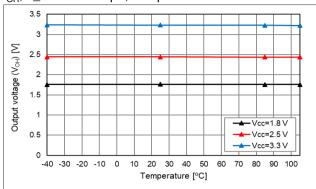
50 % V_{CC} , L_CMOS = 15 pF, Temp. Char.



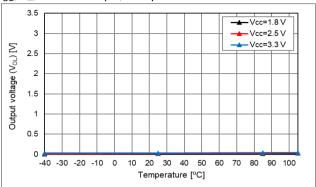
(7-5) Output Voltage

fo = 20 MHz

V_{OH}, L_CMOS = 15 pF, Temp. Char.

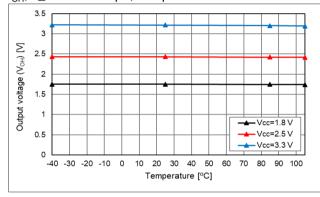


 V_{OL} , L_CMOS = 15 pF, Temp. Char.

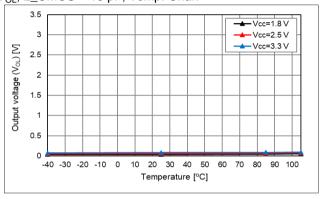


fo = 40 MHz

V_{OH}, L_CMOS = 15 pF, Temp. Char.

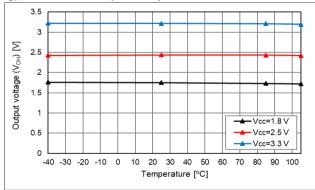


V_{OL}, L_CMOS = 15 pF, Temp. Char.

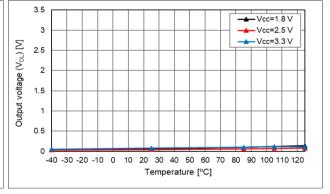


fo = 72 MHz

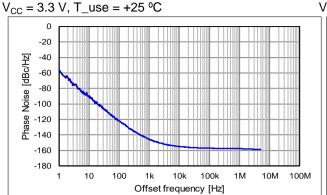
V_{OH}, L_CMOS = 15 pF, Temp. Char.

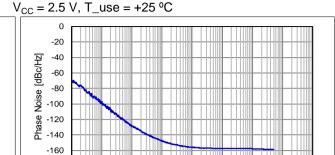


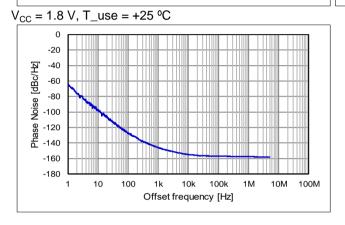
 V_{OL} , L_CMOS = 15 pF, Temp. Char.



(7-6) Phase Noise, Phase Jitter, and Jitter fo = 20 MHz







Phase Jitter (Offset frequency: 12 kHz to 5 MHz)

10k

Offset frequency [Hz]

100k

10M

100M

V_{CC}	Phase Jitter					
3.3 V	0.31 ps					
2.5 V	0.31 ps					
1.8 V	0.32 ps					

Jitter (T_use = +25 $^{\circ}$ C, V_{CC} = 3.3 V)

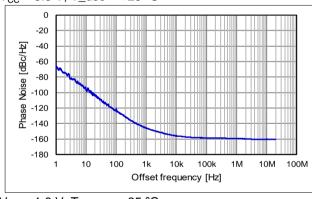
-180

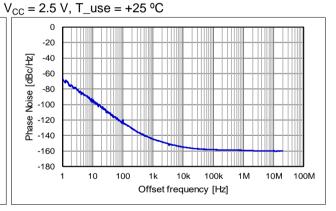
10

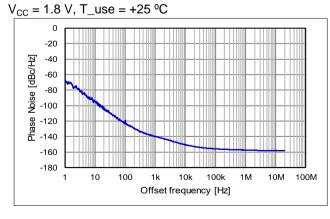
Total jitter (BER = 10 ⁻¹²)	31.3 ps
RMS jitter	1.8 ps
Peak to peak jitter	15 ps

fo = 40 MHz









Phase Jitter (Offset frequency: 12 kHz to 20 MHz)

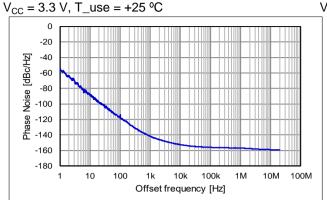
V_{CC}	Phase Jitter
3.3 V	0.24 ps
2.5 V	0.26 ps
1.8 V	0.32 ps

Jitter (T_use = +25 $^{\circ}$ C, V_{CC} = 3.3 $^{\circ}$ V)

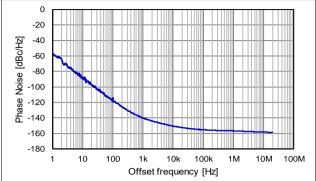
Total jitter (BER = 10 ⁻¹²)	22.3 ps
RMS jitter	1.8 ps
Peak to peak jitter	16 ps

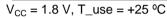
(7-6) Phase Noise and Phase Jitter [cont'd]

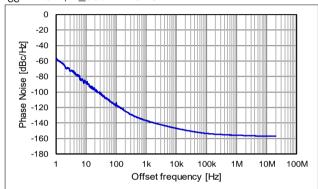
fo = 72 MHz











Phase Jitter (Offset frequency: 12 kHz to 20 MHz)

V_{CC}	Phase Jitter
3.3 V	0.16 ps
2.5 V	0.17 ps
1.8 V	0.20 ps

Jitter (T_use = +25 $^{\circ}$ C, V_{CC} = 3.3 V)

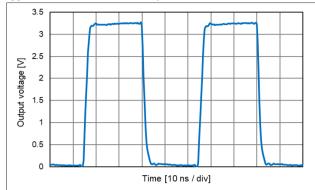
Total jitter (BER = 10 ⁻¹²)	21.8 ps
RMS jitter	1.8 ps
Peak to peak jitter	16 ps

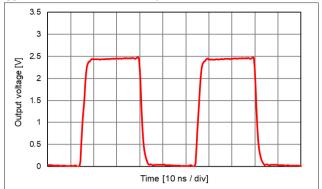
(7-7) Output Waveform

fo = 20 MHz

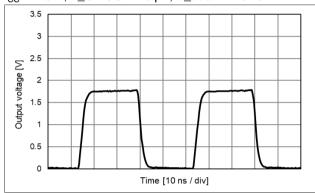
 V_{CC} = 3.3 V, L_CMOS = 15 pF, T_use = +25 °C

 $V_{CC} = 2.5 \text{ V}, \text{ L_CMOS} = 15 \text{ pF}, \text{T_use} = +25 \, ^{\circ}\text{C}$





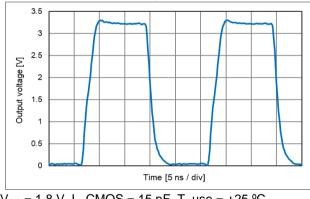
 $V_{CC} = 1.8 \text{ V}, L_CMOS = 15 \text{ pF}, T_use = +25 ^{\circ}C$

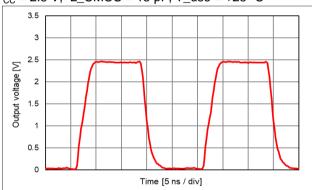


fo = 40 MHz

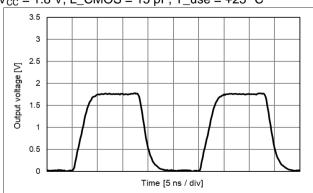
 $V_{CC} = 3.3 \text{ V}, L_CMOS = 15 \text{ pF}, T_use = +25 \, ^{\circ}C$

 $V_{CC} = 2.5 \text{ V}, \text{ L_CMOS} = 15 \text{ pF}, \text{T_use} = +25 \, {}^{\circ}\text{C}$





 $V_{CC} = 1.8 \text{ V}, L_CMOS = 15 \text{ pF}, T_use = +25 ^{\circ}C$

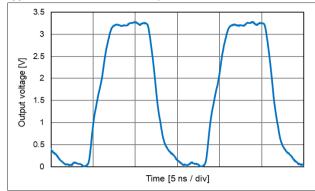


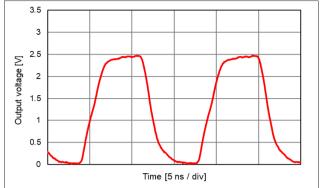
(7-7) Output Waveform [cont'd]

fo = 72 MHz

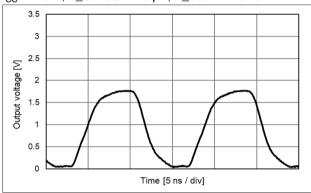
$$V_{CC} = 3.3 \text{ V}, L_CMOS = 15 \text{ pF}, T_use = +25 \, ^{\circ}C$$

 $V_{CC} = 2.5 \text{ V}, \text{ L_CMOS} = 15 \text{ pF}, \text{T_use} = +25 \text{ }^{\circ}\text{C}$





 V_{CC} = 1.8 V, L_CMOS = 15 pF, T_use = +25 °C

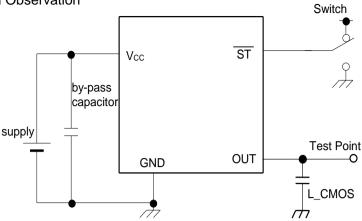


Page 20 / 35

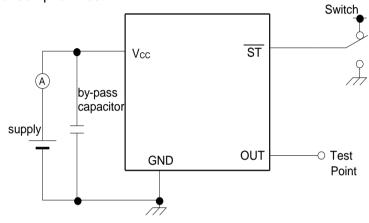
Spec No : SGxxxxCAN_E_Ver1.94

[8] Test Circuit

(8-1) Waveform Observation



(8-2) Current Consumption Test



*Standby current test should be $\overline{ST} = GND$.

(8-3) Condition

(1) Oscilloscope

The bandwidth should be minimum 5 times wider than measurement frequency

The probe ground should be placed closely to the test point and the lead length should be
as short as possible

- * It is recommended to use miniature socket. (Don't use earth lead.)
- (2) L_CMOS includes probe capacitance.
- (3) A 0.01 μF to a 0.1 μF bypass capacitor should be connected between V_{CC} and GND pins located close to the device
- (4) Use a current meter with a low internal impedance
- (5) Power Supply

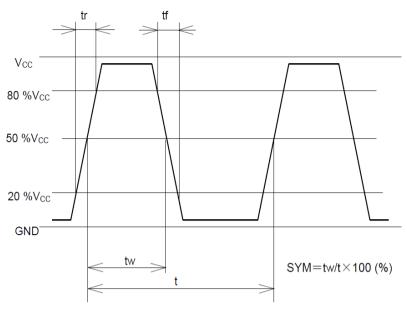
Power supply startup time (0 %V_{CC} \to 90 %V_{CC}) should be more than 150 µs Power supply impedance should be as low as possible

Page 21 / 35

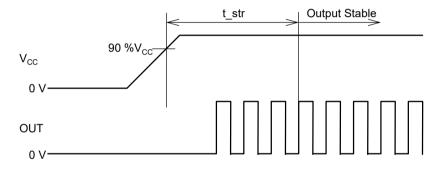
Spec No : SGxxxxCAN_E_Ver1.94

(8-4) Timing Chart

(1) Output Waveform and Level

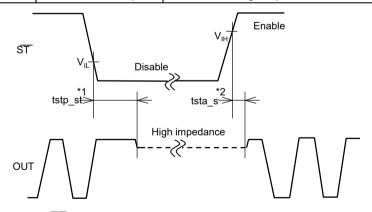


(2) Output Frequency Timing



(3) ST Function and Timing

anonon ana mini	" '9	
ST Terminal	Osc. circuit	Output status
"H" or OPEN	Oscillation	Specified frequency: Enable
"L"	Oscillation stop	High impedance: Disable



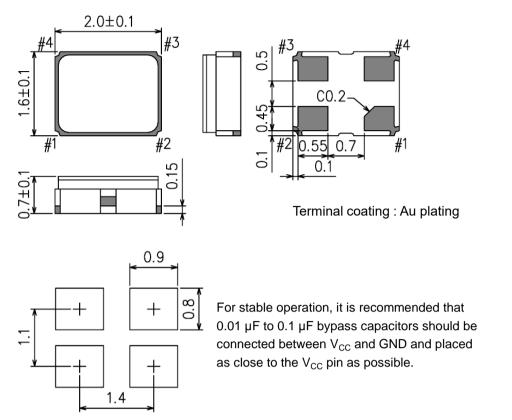
- *1 The period from $\overline{ST} = V_{IL}$ to OUT = High impedance (Disable)
- *2 The period from $\overline{ST} = V_{IH}$ to OUT = Enable
- * Judge of starting output: $V_{OH} \ge 80 \ \% V_{CC}, \ V_{OL} \le 20 \ \% V_{CC}, \ fout is within fo <math>\pm \ 1 \ 000 \times 10^{-6}$
- * ST terminal voltage level should not exceed supply voltage when using ST function.

 Please note that ST rise time should not exceed supply voltage rise time at the start-up.

Page 22 / 35 Spec No : SGxxxxCAN_E_Ver1.94

[9] Outline Drawing and Recommended Footprint (9-1) SG2016CAN

Units: mm

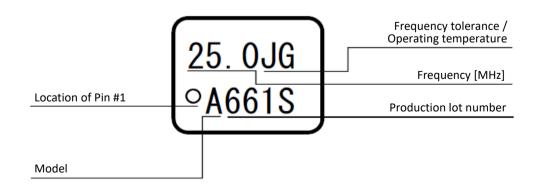


Reference Weight Typ.: 9.9 mg

Terminal Assignment

Pin #	Connection	Function			
			ST terminal		
#1	ST	ST function	Osc. Circuit	Output	
#1		"H" or OPEN	Oscillation	Specified frequency: Enable	
				"L"	Oscillation stop
#2	GND	GND terminal			
#3	OUT	Output terminal			
#4	V _{cc}	V _{CC} terminal			

Marking



Page 23 / 35 Spec No : SGxxxxCAN_E_Ver1.94

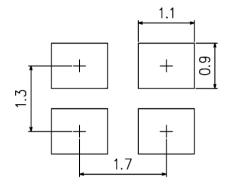
(9-2) SG-210STF

2.5±0.15

#4

CO.3

Terminal coating : Au plating



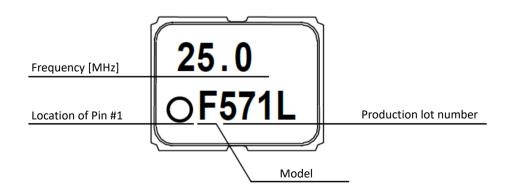
For stable operation, it is recommended that 0.01 μ F to 0.1 μ F bypass capacitors should be connected between V_{CC} and GND and placed as close to the V_{CC} pin as possible.

Reference Weight Typ.: 14 mg

Terminal Assignment

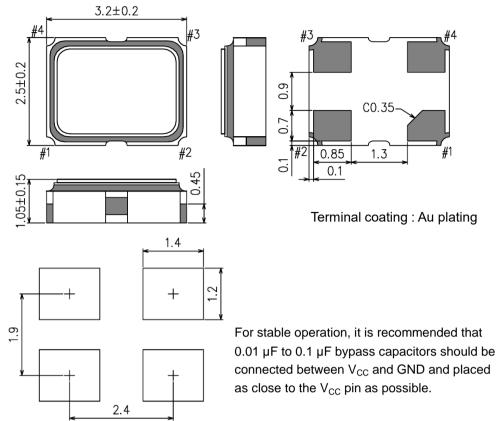
Pin #	Connection	Function			
			ST terminal		
#1	ST	ST function	Osc. Circuit	Output	
#1		"H" or OPEN	Oscillation	Specified frequency: Enable	
		"L"	Oscillation stop	High impedance: Disable	
#2	GND	GND terminal			
#3	OUT	Output terminal			
#4	V _{CC}	V _{CC} terminal			

Marking



Page 24 / 35 Spec No : SGxxxxCAN_E_Ver1.94

(9-3) SG3225CAN

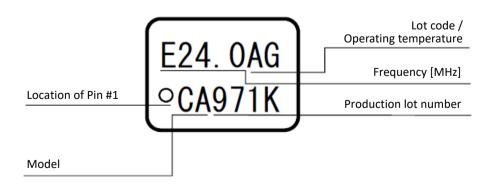


Reference Weight Typ.: 25 mg

Terminal Assignment

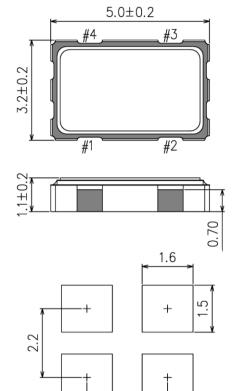
Pin #	Connection	Function				
			ST terminal			
#1	ST	ST function	Osc. Circuit	Output		
#1		#1 51	"H" or OPEN	Oscillation	Specified frequency: Enable	
						"L"
#2	GND	GND terminal				
#3	OUT	Output terminal				
#4	V _{CC}	V _{CC} terminal				

Marking



Page 25 / 35 Spec No : SGxxxxCAN_E_Ver1.94

(9-4) SG5032CAN



2.54

2.54 #4 CO.47 O.63 | 1.2 | 1.34 | #1 | 0.8

Terminal coating: Au plating

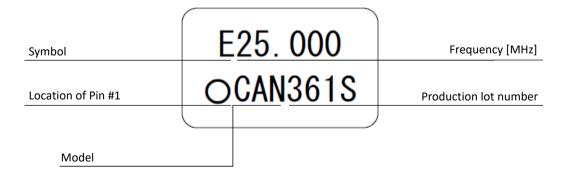
For stable operation, it is recommended that 0.01 μ F to 0.1 μ F bypass capacitors should be connected between V_{CC} and GND and placed as close to the V_{CC} pin as possible.

Reference Weight Typ.: 52 mg

Terminal Assignment

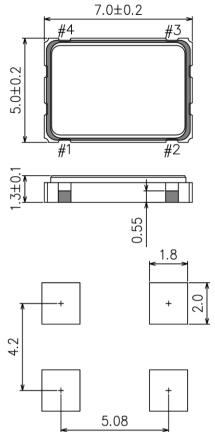
Pin #	Connection	Function				
		ST terminal	ST terminal			
#1	ST	ST function	Osc. Circuit	Output		
#1		"H" or OPEN	Oscillation	Specified frequency: Enable		
					"L"	Oscillation stop
#2	GND	GND terminal				
#3	OUT	Output terminal				
#4	V _{CC}	V _{CC} terminal				

Marking



Page 26 / 35 Spec No : SGxxxxCAN_E_Ver1.94

(9-5) SG7050CAN



5.08 #3 #4 092 0.26 #1 1.40 0.26

Terminal coating: Au plating

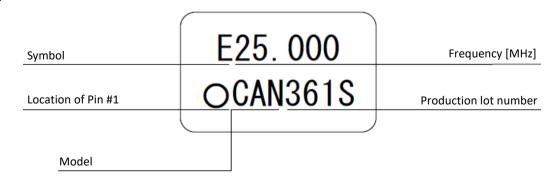
For stable operation, it is recommended that 0.01 μ F to 0.1 μ F bypass capacitors should be connected between V_{CC} and GND and placed as close to the V_{CC} pin as possible.

Reference Weight Typ.: 147 mg

Terminal Assignment

Pin #	Connection	Function			
	#1 <u>S</u> T	ST terminal	ST terminal		
#1		ST function	Osc. Circuit	Output	
#1		"H" or OPEN	Oscillation	Specified frequency: Enable	
		"L"	Oscillation stop	High impedance: Disable	
#2	GND	GND terminal			
#3	OUT	Output terminal			
#4	V _{CC}	V _{CC} terminal			

Marking



Page 27 / 35

Spec No : SGxxxxCAN_E_Ver1.94

[10] Moisture Sensitivity Level and Electro-Static Discharge Ratings

(10-1) Moisture Sensitivity Level (MSL)

Parameter	Specification	Conditions
MSL	LEVEL 1	IPC/JEDEC J-STD-020D.1

(10-2) Electro-Static Discharge (ESD)

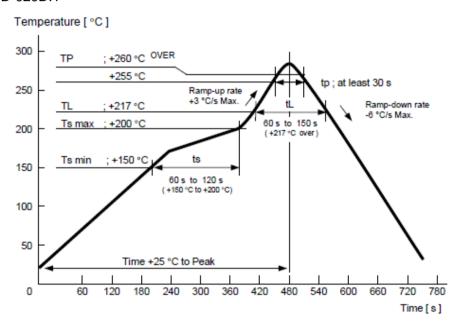
Parameter	Specification	Conditions
НВМ	2 000 V Min.	EIAJ ED-4701-1 C111A, 100 pF, 1.5 kΩ, 3 times
MM	200 V Min.	EIAJ ED-4701-1 C111, 200 pF, 0 Ω, 1 time
CDM	750 V Min	AEC-Q100-011 (DCDM) * only for SG2016CAN

(10-3) Latch-Up

Parameter	Specification	Conditions
Latch-up	100 mA Min.	EIAJ ED-4701-1 C113

[11] Reflow Profiles

IPC/JEDEC J-STD-020D.1



Page 28 / 35

Spec No: SGxxxxCAN_E_Ver1.94

[12] Packing Information

(12-1) SG2016CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G004801xxxxxxx) are a code that defines the packing quantity. The standard is "00" for a 3 000 pcs/Reel.

(2) Taping Specification

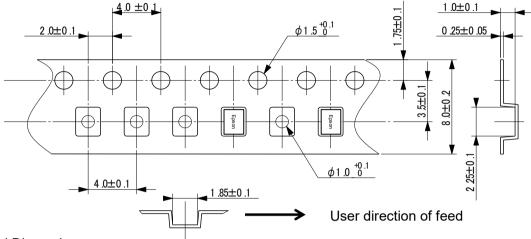
Subject to EIA-481, IEC-60286 and JIS C0806

1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)

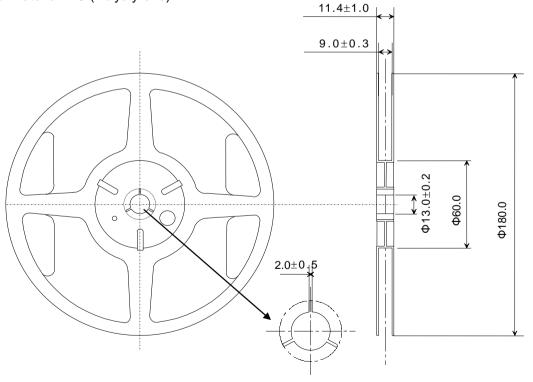
Units: mm



2) Reel Dimensions

Center Material: PS (Polystyrene) Reel Material: PS (Polystyrene)

Units: mm



3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

Page 29 / 35 Spec No : SGxxxxCAN_E_Ver1.94

(12-2) SG-210STF

(1) Packing Quantity

The last two digits of the Product Number (X1G004171xxxxxxx) are a code that defines the packing quantity. The standard is "00" for a 3 000 pcs/Reel.

(2) Taping Specification

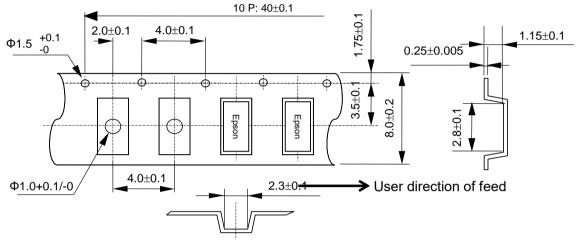
Subject to EIA-481, IEC-60286 and JIS C0806

1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)

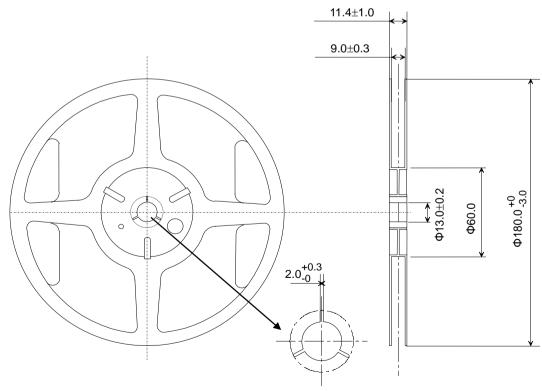
Units: mm



2) Reel Dimensions

Center Material: PS (Polystyrene) Reel Material: PS (Polystyrene)

Units: mm



3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

Page 30 / 35 Spec No : SGxxxxCAN_E_Ver1.94

(12-3) SG3225CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G005961xxxxxxx) are a code that defines the packing quantity. The standard is "15" for a 2 000 pcs/Reel.

(2) Taping Specification

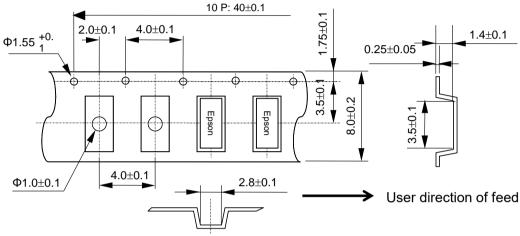
Subject to EIA-481, IEC-60286 and JIS C0806

1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)

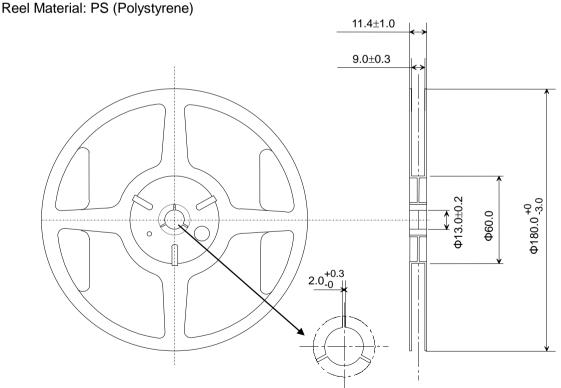
Units: mm



2) Reel Dimensions

Center Material: PS (Polystyrene)

Units: mm



3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

Page 31 / 35 Spec No : SGxxxxCAN_E_Ver1.94

Units: mm

(12-4) SG5032CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G004451xxxxxxx) are a code that defines the packing quantity. The standard is "00" for a 1 000 pcs/Reel.

(2) Taping Specification

Subject to EIA-481, IEC-60286 and JIS C0806

1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)

User direction of feed 0 0 0 0 Carrier tape Top tape Symbol Α В С D Е Value φ1.5 4.0±0.1 8.0±0.1 7.25±0.2 12.0±0.2 1.40±0.1 +0.1/-0

2) Reel Dimensions

Center Material: PS (Polystyrene) Reel Material: PS (Polystyrene)

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3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

Page 32 / 35 Spec No : SGxxxxCAN_E_Ver1.94

(12-5) SG7050CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G004481xxxxxxx) are a code that defines the packing quantity. The standard is "00" for a 1 000 pcs/Reel.

(2) Taping Specification

Subject to EIA-481, IEC-60286 and JIS C0806

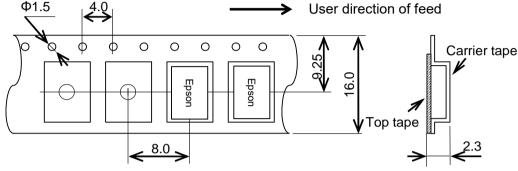
1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)

ape

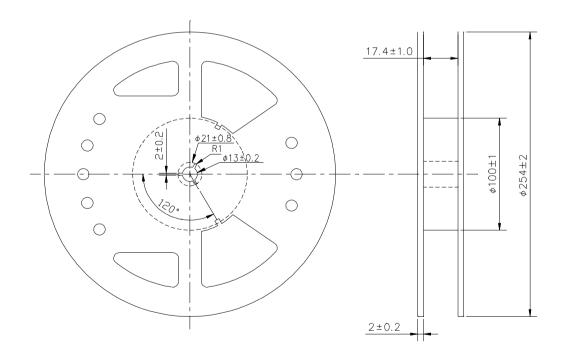
Units: mm



2) Reel Dimensions

Center Material: PS (Polystyrene) Reel Material: PS (Polystyrene)

Units: mm



3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

Page 33 / 35 Spec No : SGxxxxCAN_E_Ver1.94

[13] Handling Precautions

Prior to using this product, please carefully read the section entitled "Precautions" on our Web site (https://www5.epsondevice.com/en/information/#precaution) for instructions on how to handle and use the product properly to ensure optimal performance of the product in your equipment.

Before using the product under any conditions other than those specified therein, please consult with us to verify and confirm that the performance affected by use under such conditions.

In addition to the foregoing precautions, in order to avoid the deteriorating performance of the product, we strongly recommend that you DO NOT use the product under ANY of the following conditions:

- (1) Mounting the product on a board using water-soluble solder flux and using the product without removing the residue of the flux completely from the board. The residue of such flux that is soluble in water or water-soluble cleaning agent, especially the residues which contains active halogens, will negatively affect the performance and reliability of the product.
- (2) Using the product in any manner that will result in any shock or impact to the product.
- (3) Using the product in places where the product is exposed to water, chemicals, organic solvent, sunlight, dust, corrosive gasses, or other materials.
- (4) Using the product in places where the product is exposed to static electricity or electromagnetic waves.
- (5) Applying ultrasonic cleaning without advance verification and confirmation that the product will not be affected by such a cleaning process, because it may damage the crystal,
- (6) Using the product under any other conditions that may negatively affect the performance and/or reliability of the product.
- (7) Power supply with ripple may cause of incorrect operation or degradation of phase noise characteristics, so please evaluate before use.
- (8) Supply voltage should be increased monotonically.
 In addition, please do not power on at midpoint potential since that may cause malfunction or not output.
- (9) Frequency aging is from environmental tests results to the expectation of the amount of the frequency variation. This doesn't guarantee the product-life cycle.

Should any customer use the product in any manner contrary to the precautions and/or advice herein, such use shall be done at the customer's own risk.

Page 34 / 35 Spec No : SGxxxxCAN E Ver1.94

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification. ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major manufacturers as standard.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

■ Explanation of marks used in this datasheet



●Pb free.



●Complies with EU RoHS directive.

*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive

(Contains Pb in sealing glass, high melting temperature type solder or other)

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Page 35 / 35 Spec No : SGxxxxCAN E Ver1.94